



CoreLED P/N 12002-STAR-E17

- 2H x 2V Flood IES NEMA Type lens
- Nichia E17 LED source
- 20mm Starboard for easy prototyping and evaluation

**SMO Product Description:** 

The SMO product family is a series of molded high-temperature silicone miniature lenses that attach directly to PCB with solder clip using standard reflow method. These components achieve high light collection efficiency, a variety of engineered beam patterns, and are supplied for high volume pick and place electronics assembly.

**Key Features:** 

- $\circ$   $\,$  Optical lens is reflow mounted at the same time as LED assembly
- Supplied in tape and reel
- o Increased control of light output
- $\circ$  Precision alignment (within ±0.1mm)
- $\circ$  Family of optical beam patterns that will work using IR reflow
- Reflow solder clip directly attached to lens
- Standard pick and place equipment
- Manufactured without the need for additional components to attach the optics

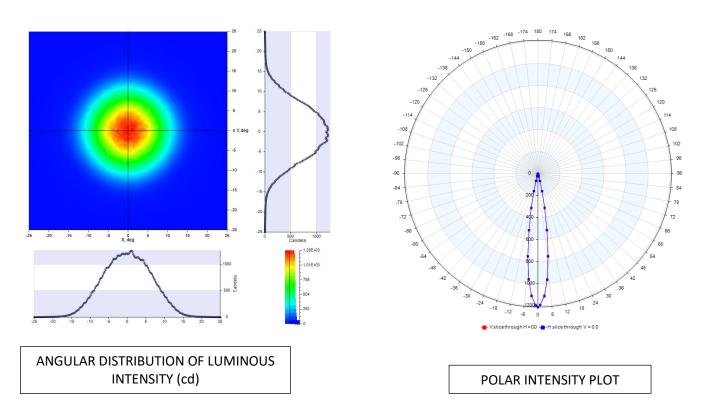
# STARBOARD mounted optics are meant for PROTOTYPE and EVALUATION purposes only



#### **Emitted Pattern Profile**

#### Nichia E17 (Measured) 1717 LED package

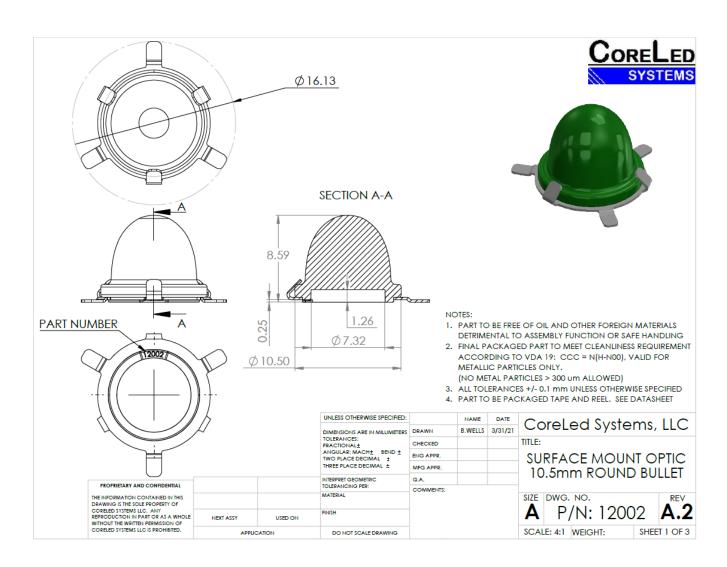
IES NEMA Type	2H x 2V
Maximum Candela	1216
Horizontal Beam Angle (50%)	16.5
Vertical Beam Angle (50%)	16.5
Horizontal Field Angle (10%)	27.8
Vertical Field Angle (10%)	27.8
Total Lamp Lumens	100



## IES files and Raytrace models are available upon request from CoreLed Engineering.



#### Mechanical Profile: SMO Bullet Collimator



Mechanical design features shown with solder clip

CAD files available upon request from CoreLed Engineering



#### **LED Information**



### NCSWE17AT

Pb-free Reflow Soldering Application

RoHS Compliant



#### SPECIFICATIONS

#### (1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	I <sub>F</sub>	700	mA
Pulse Forward Current	Ipp	1000	mA
Reverse Voltage	VR	5	v
Power Dissipation	Pp	2.31	W
Operating Temperature	Toor	-40~100	°C
Storage Temperature	T <sub>stg</sub>	-40~100	°C
Junction Temperature	T <sub>2</sub>	135	°C

\* Absolute Maximum Ratings at  $T_c$ =25°C.

\*  $I_{\mu\nu}$  conditions with pulse width  ${\leq}10\text{ms}$  and duty cycle  ${\leq}10\%.$ 

#### (2) Initial Electrical/Optical Characteristics

It	em	Symbol	Condition	Тур	Max	Unit
Forward Voltage		VF	I <sub>F</sub> =350mA	3.0	-	v
Reverse Current		IR	$V_R = 5V$	-	-	μA
R70	Luminous Flux	Φv	I <sub>F</sub> =350mA	158	-	lm
	Color Rendering Index	Ra	I <sub>F</sub> =350mA	72	-	-
R8000	Luminous Flux	Φ,	I <sub>F</sub> =350mA	148	-	Im
	Color Rendering Index	Ra	I <sub>F</sub> =350mA	82	-	-
R9050	Luminous Flux	Φv	I <sub>F</sub> =350mA	125	-	lm
	Color Rendering Index	Ra	I <sub>F</sub> =350mA	92	-	-
R9080	Luminous Flux	Φv	I <sub>F</sub> =350mA	118	-	lm
	Color Rendering Index	Ra	I <sub>F</sub> =350mA	92	-	-
Chromaticity Coordinate	х	-	I <sub>F</sub> =350mA	0.3447	-	-
	y	-	I <sub>F</sub> =350mA	0.3553	-	-
Thermal Resistance		Rec	-	0.5	1.0	°C/W

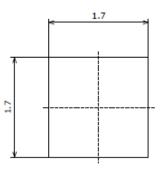
\* Characteristics at Tc=25°C.

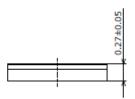
\* Luminous Flux value as per CIE 127:2007 standard.

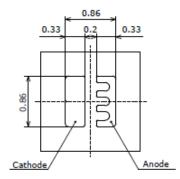
\* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

\* The thermal resistance value (R<sub>BUC</sub>) is used to perform logical analysis (e.g. computer-based thermal analysis simulation) and represents a thermal resistance between the die to the T<sub>C</sub> measurement point (PCB used: Aluminum PCB t=1.5mm, Insulating layer t=0.12mm).

\* For more details on thermal resistance, see CAUTIONS, (6) Thermal Management.



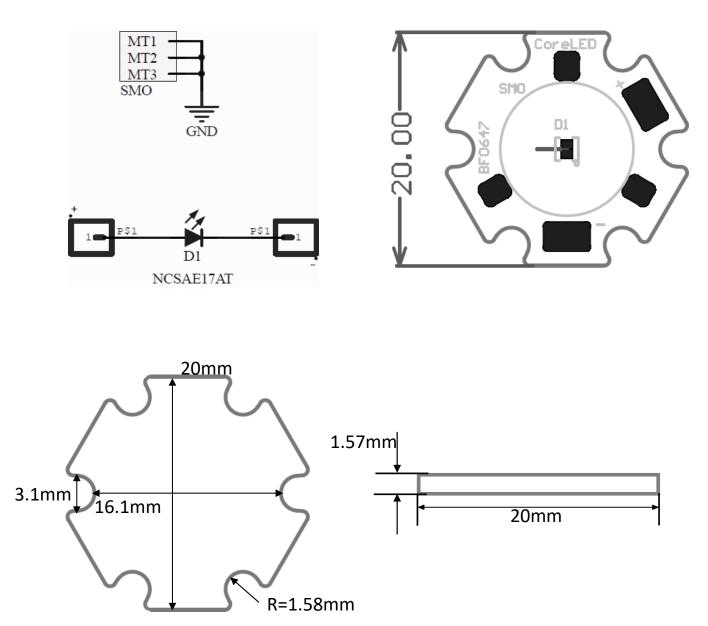








#### **Starboard Schematic**



STARBOARD mounted optics are meant for PROTOTYPE and EVALUATION purposes only



Electrical:

From LED Data sheet: recommended operation is Typical 3.0V at 350mA (1 Watt to provide 150 lumens).

Thermal:

Recommended attachment to heat sink to dissipate 1W (3.0V at 350mA). LED is rated higher and can be run up to 700mA with appropriate heatsinking provided.

Packaging:

Individually packaged in static controlled bag.